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Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

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BLF6G10-160RN; BLF6G10LS-160RN

Power LDMOS transistor

Rev. 3 — 1 September 2015

AMPLEON
Product data sheet

1. Product profile

1.1 General description

160 W LDMOS power transistor for base station applications at frequencies from 700 MHz to 1000 MHz.

Table 1. Typical performance

Typical RF performance at $T_{case} = 25\text{ °C}$ in a class-AB production test circuit.

Mode of operation	f (MHz)	V_{DS} (V)	$P_{L(AV)}$ (W)	G_p (dB)	η_D (%)	ACPR (dBc)
2-carrier W-CDMA	920 to 960	32	32	22.5	27	-41 ^[1]

[1] Test signal: 3GPP; test model 1; 64 DPCH; PAR = 7.5 dB at 0.01 % probability on CCDF per carrier; carrier spacing 5 MHz.

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

1.2 Features

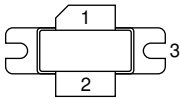
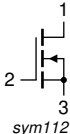
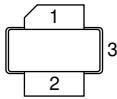
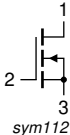
- Typical 2-carrier W-CDMA performance at frequencies of 920 MHz and 960 MHz, a supply voltage of 32 V and an I_{Dq} of 1200 mA:
 - ◆ Average output power = 32 W
 - ◆ Power gain = 22.5 dB
 - ◆ Efficiency = 27 %
 - ◆ ACPR = -41 dBc
- Easy power control
- Integrated ESD protection
- Excellent ruggedness
- High efficiency
- Excellent thermal stability
- Designed for broadband operation (700 MHz to 1000 MHz)
- Internally matched for ease of use
- Compliant to Directive 2002/95/EC, regarding restriction of hazardous substances (RoHS)

1.3 Applications

- RF power amplifiers for GSM, GSM EDGE, W-CDMA and CDMA base stations and multi carrier applications in the 700 MHz to 1000 MHz frequency range.

2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	Graphic symbol
BLF6G10-160RN (SOT502A)			
1	drain		 sym112
2	gate		
3	source ^[1]		
BLF6G10LS-160RN (SOT502B)			
1	drain		 sym112
2	gate		
3	source ^[1]		

[1] Connected to flange.

3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BLF6G10-160RN	-	flanged LDMOST ceramic package; 2 mounting holes; 2 leads	SOT502A
BLF6G10LS-160RN	-	earless flanged LDMOST ceramic package; 2 leads	SOT502B

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	drain-source voltage		-	65	V
V_{GS}	gate-source voltage		-0.5	+13	V
I_D	drain current		-	39	A
T_{stg}	storage temperature		-65	+150	°C
T_j	junction temperature		-	225	°C

5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Type	Typ	Unit
$R_{th(j-case)}$	thermal resistance from junction to case	$T_{case} = 80\text{ °C};$ $P_L = 32\text{ W}$	BLF6G10-160RN	0.5	K/W
			BLF6G10LS-160RN	0.44	K/W

6. Characteristics

Table 6. Characteristics

$T_j = 25\text{ °C}$ unless otherwise specified

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{(BR)DSS}$	drain-source breakdown voltage	$V_{GS} = 0\text{ V}; I_D = 0.72\text{ mA}$	65	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	$V_{DS} = 10\text{ V}; I_D = 216\text{ mA}$	1.4	1.9	2.4	V
V_{GSq}	gate-source quiescent voltage	$V_{DS} = 32\text{ V};$ $I_D = 1300\text{ mA}$	1.7	2.2	2.7	V
I_{DSS}	drain leakage current	$V_{GS} = 0\text{ V}; V_{DS} = 32\text{ V}$	-	-	5	μA
I_{DSX}	drain cut-off current	$V_{GS} = V_{GS(th)} + 3.75\text{ V};$ $V_{DS} = 10\text{ V}$	30.6	39	-	A
I_{GSS}	gate leakage current	$V_{GS} = 13\text{ V}; V_{DS} = 0\text{ V}$	-	-	450	nA
g_{fs}	forward transconductance	$V_{DS} = 10\text{ V}; I_D = 7.5\text{ A}$	-	13.5	-	S
$R_{DS(on)}$	drain-source on-state resistance	$V_{GS} = V_{GS(th)} + 3.75\text{ V};$ $I_D = 7.5\text{ A}$	-	0.07	-	Ω
C_{rs}	feedback capacitance	$V_{GS} = 0\text{ V}; V_{DS} = 32\text{ V};$ $f = 1\text{ MHz}$	-	4.2	-	pF

7. Application information

Table 7. Application information

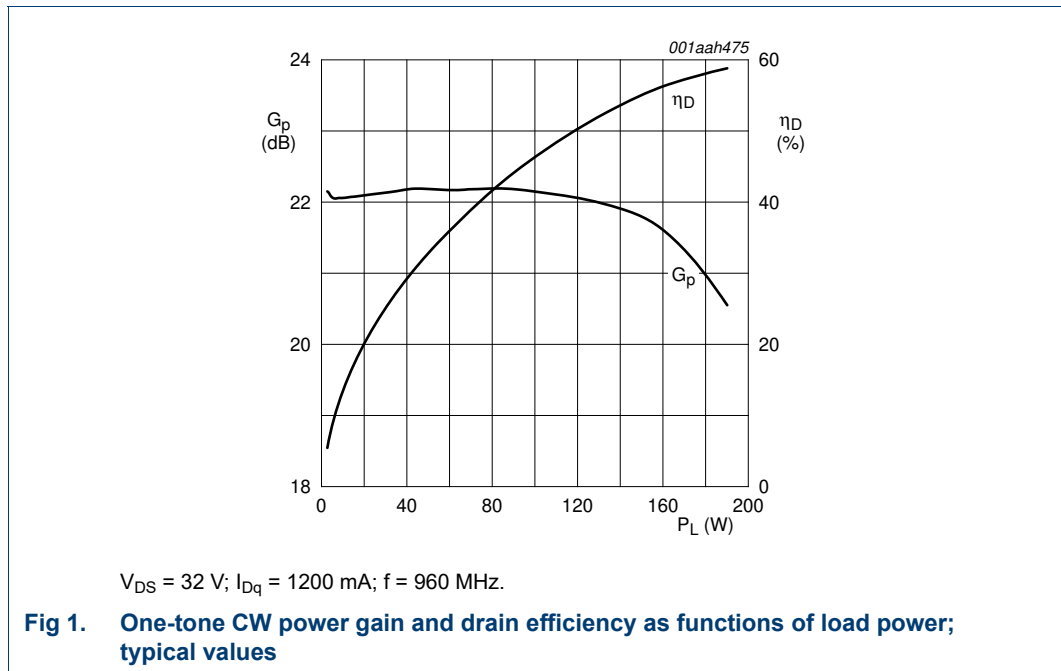
Mode of operation: 2-carrier W-CDMA; PAR 7.5 dB at 0.01 % probability on CCDF; 3GPP test model 1; 1-64 PDPCH; $f_1 = 922.5\text{ MHz}; f_2 = 927.5\text{ MHz}; f_3 = 952.5\text{ MHz}; f_4 = 957.5\text{ MHz};$ RF performance at $V_{DS} = 32\text{ V}; I_{Dq} = 1200\text{ mA}; T_{case} = 25\text{ °C};$ unless otherwise specified; in a class-AB production test circuit.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$P_{L(AV)}$	average output power		-	32	-	W
G_p	power gain	$P_{L(AV)} = 32\text{ W}$	21	22.5	-	dB
RL_{in}	input return loss	$P_{L(AV)} = 32\text{ W}$	-	-8	-5.5	dB
η_D	drain efficiency	$P_{L(AV)} = 32\text{ W}$	25	27	-	%
ACPR	adjacent channel power ratio	$P_{L(AV)} = 32\text{ W}$	-	-41	-38	dBc

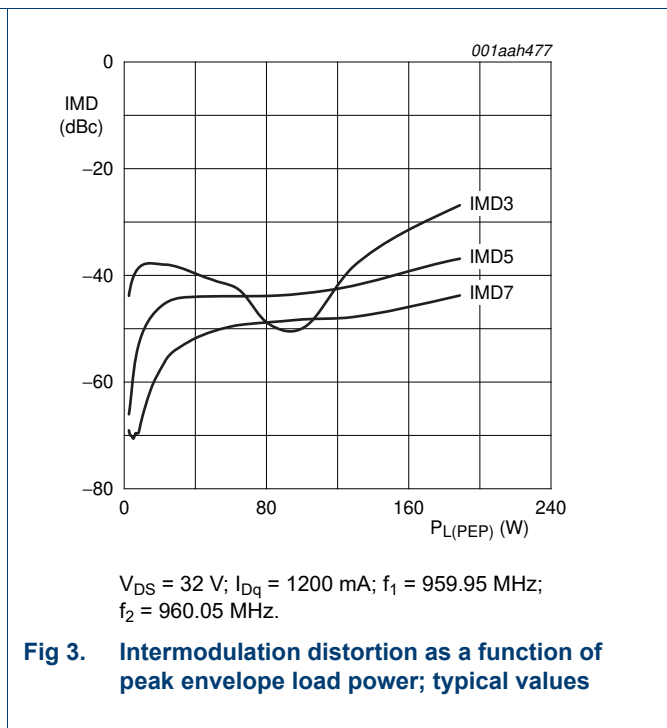
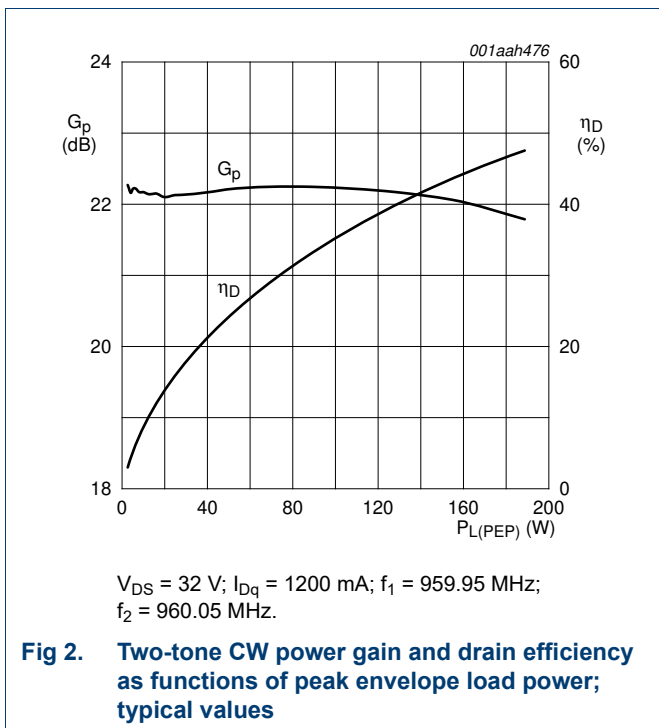
7.1 Ruggedness in class-AB operation

The BLF6G10-160RN and BLF6G10LS-160RN are capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions: $V_{DS} = 32\text{ V}; I_{Dq} = 1200\text{ mA}; P_L = 160\text{ W (CW)}; f = 960\text{ MHz}.$

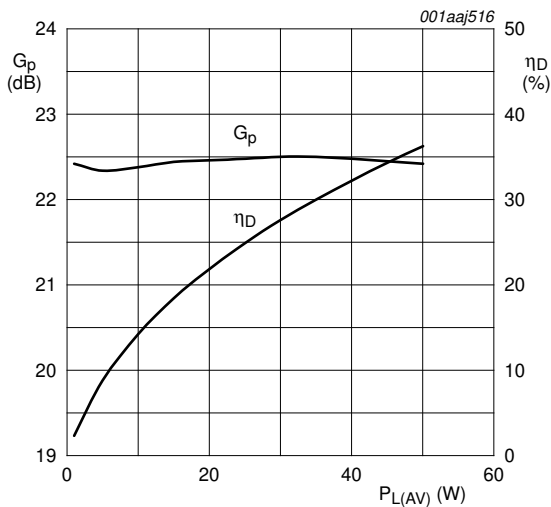
7.2 One-tone CW



7.3 Two-tone CW

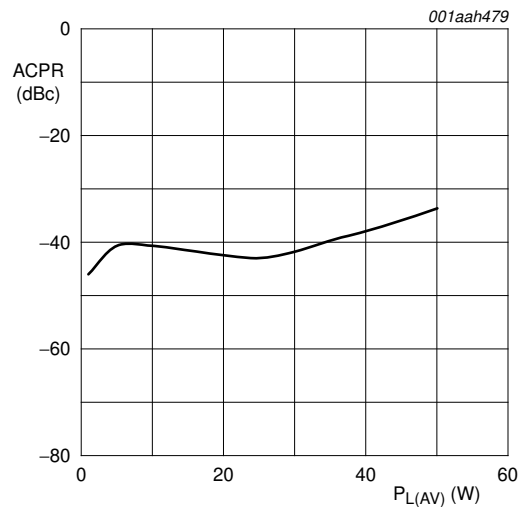


7.4 2-carrier W-CDMA



$V_{DS} = 32\text{ V}$; $I_{DQ} = 1200\text{ mA}$; $f_1 = 952.5\text{ MHz}$; $f_2 = 957.5\text{ MHz}$; carrier spacing 5 MHz.

Fig 4. 2-carrier W-CDMA power gain and drain efficiency as functions of average load power; typical values



$V_{DS} = 32\text{ V}$; $I_{DQ} = 1200\text{ mA}$; $f_1 = 952.5\text{ MHz}$; $f_2 = 957.5\text{ MHz}$; carrier spacing 5 MHz.

Fig 5. 2-carrier W-CDMA adjacent channel power ratio as function of average load power; typical values

8. Test information

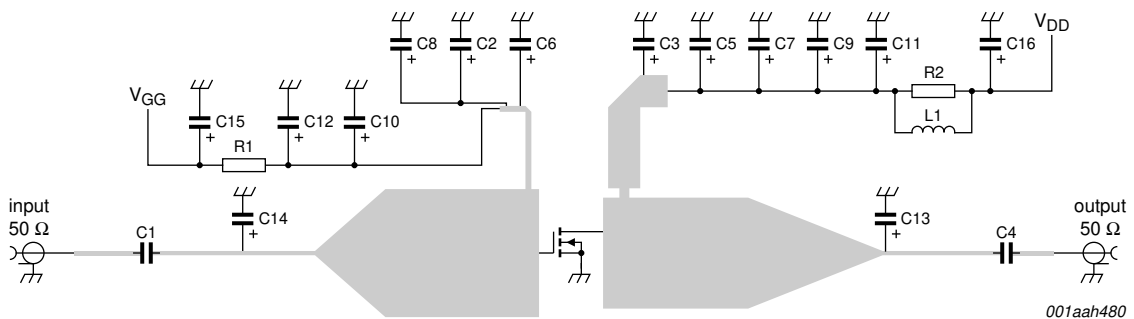


Fig 6. Test circuit for operation at 900 MHz

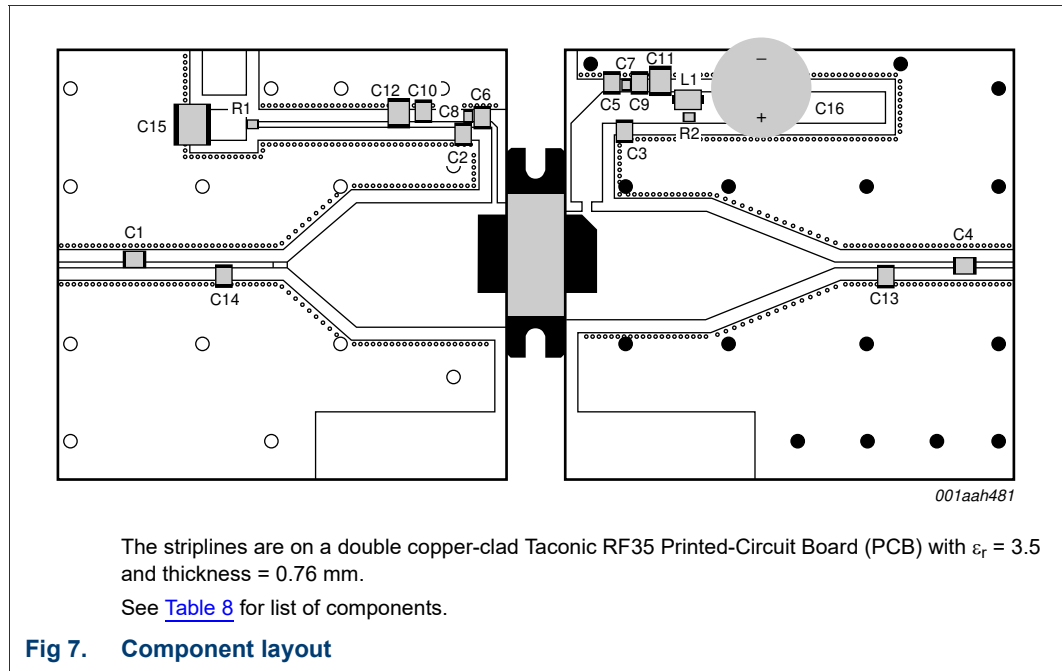


Table 8. List of components (see [Figure 6](#) and [Figure 7](#))

All capacitors should be soldered vertically.

Component	Description	Value	Remarks
C1, C2, C3, C4	multilayer ceramic chip capacitor	68 pF	[1]
C5, C6	multilayer ceramic chip capacitor	560 pF	[1]
C7, C8	multilayer ceramic chip capacitor	330 nF; 50 V	[2]
C9, C10	multilayer ceramic chip capacitor	1.5 μ F; 50 V	[2]
C11, C12	multilayer ceramic chip capacitor	4.5 μ F; 50 V	[2]
C13	multilayer ceramic chip capacitor	2.20 pF	[1]
C14	multilayer ceramic chip capacitor	2.7 pF	[1]
C15	SMD tantalum capacitor	47 μ F; 20 V	
C16	electrolytic capacitor	220 μ F	
L1	ferrite SMD bead	-	Ferroxcube BDS 3/3/8.9-4S2 or equivalent
R1	SMD resistor	4.7 Ω ; 0.1 W	
R2	SMD resistor	6.8 Ω ; 0.1 W	

[1] American Technical Ceramics type 100B or capacitor of same quality.

[2] TDK or capacitor of same quality.

9. Package outline

Flanged ceramic package; 2 mounting holes; 2 leads

SOT502A

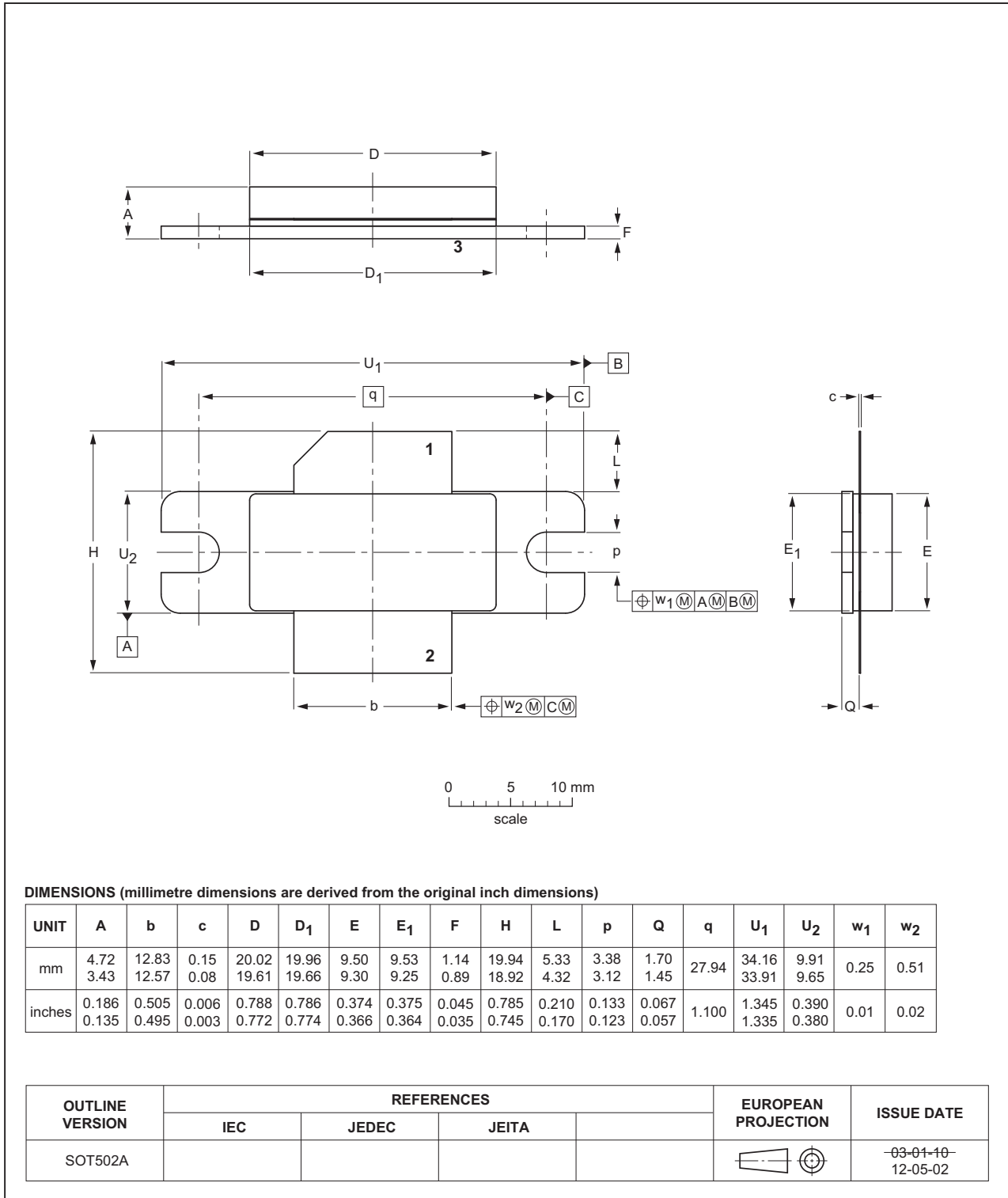


Fig 8. Package outline SOT502A

Earless flanged ceramic package; 2 leads

SOT502B

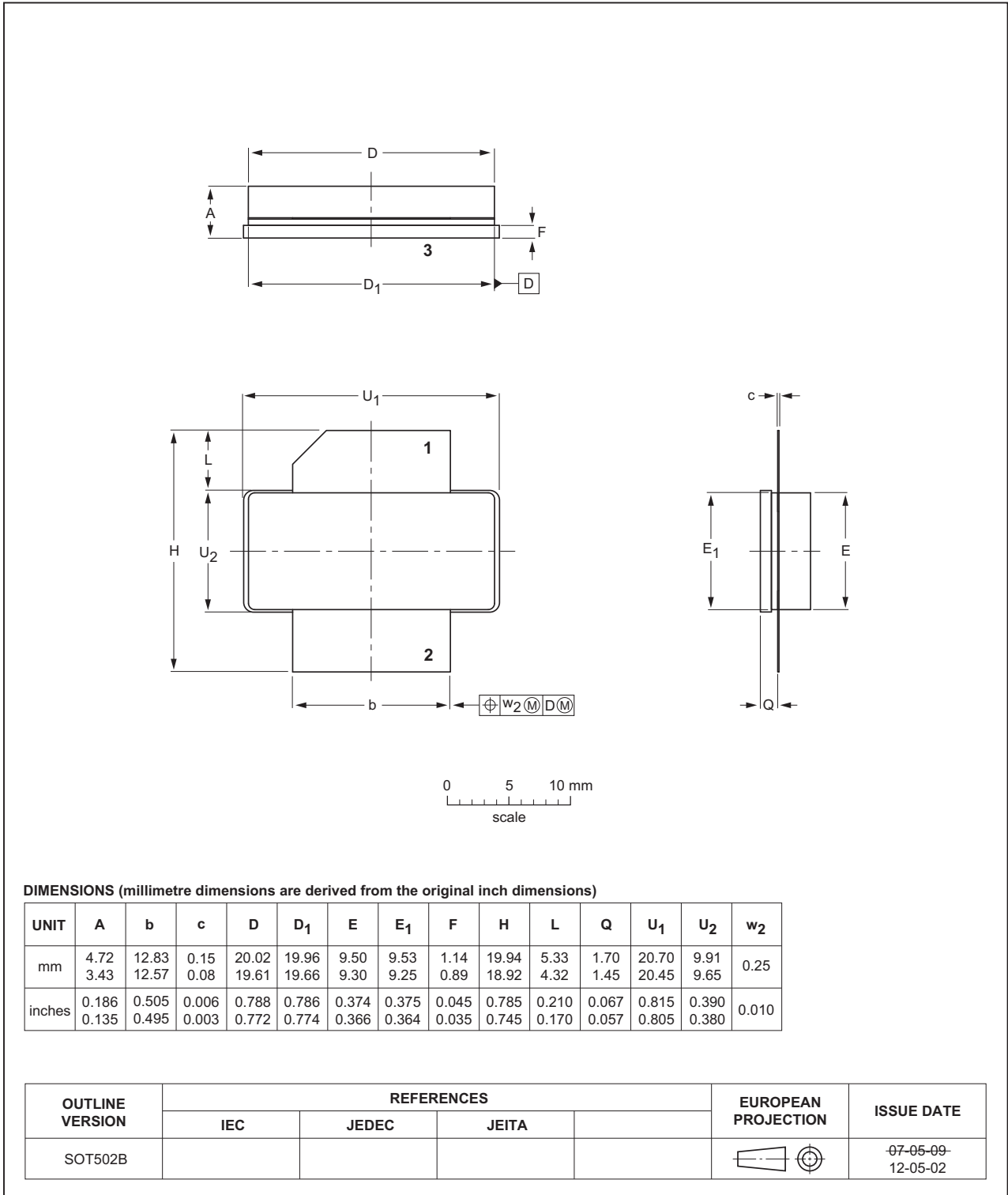


Fig 9. Package outline SOT502B

10. Abbreviations

Table 9. Abbreviations

Acronym	Description
3GPP	Third Generation Partnership Project
CCDF	Complementary Cumulative Distribution Function
CDMA	Code Division Multiple Access
CW	Continuous Wave
DPCH	Dedicated Physical CHannel
EDGE	Enhanced Data rates for GSM Evolution
GSM	Global System for Mobile communications
LDMOS	Laterally Diffused Metal-Oxide Semiconductor
LDMOST	Laterally Diffused Metal-Oxide Semiconductor Transistor
PAR	Peak-to-Average power Ratio
PDPCH	transmission Power of the Dedicated Physical CHannel
RF	Radio Frequency
SMD	Surface Mounted Device
VSWR	Voltage Standing-Wave Ratio
W-CDMA	Wideband Code Division Multiple Access

11. Revision history

Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BLF6G10-160RN_10LS-160RN#3	20150901	Product data sheet	-	BLF6G10-160RN_10LS-160RN_2
Modifications:	<ul style="list-style-type: none"> The format of this document has been redesigned to comply with the new identity guidelines of Ampleon. Legal texts have been adapted to the new company name where appropriate. 			
BLF6G10-160RN_10LS-160RN_2	20100121	Product data sheet	-	BLF6G10-160RN_10LS-160RN_1
BLF6G10-160RN_10LS-160RN_1	20090120	Product data sheet	-	-

12. Legal information

12.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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14. Contents

1 **Product profile** 1

1.1 General description 1

1.2 Features 1

1.3 Applications 2

2 **Pinning information** 2

3 **Ordering information** 2

4 **Limiting values** 2

5 **Thermal characteristics** 3

6 **Characteristics** 3

7 **Application information** 3

7.1 Ruggedness in class-AB operation 3

7.2 One-tone CW 4

7.3 Two-tone CW 4

7.4 2-carrier W-CDMA 5

8 **Test information** 5

9 **Package outline** 7

10 **Abbreviations** 9

11 **Revision history** 9

12 **Legal information** 10

12.1 Data sheet status 10

12.2 Definitions 10

12.3 Disclaimers 10

12.4 Trademarks 11

13 **Contact information** 11

14 **Contents** 12

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